





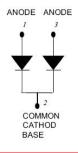
401CNQ035/401CNQ040/401CNQ045 SCHOTTKY RECTIFIER



Features

- 175°C T_J operation
- Center tap module
- High purity, high temperature epoxy encapsulation for
- enhanced mechanical strength and moisture resistance
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- · High current switching power supply
- Plating power supply
- Free-Wheeling diodes
- Reverse battery protection
- Converters
- UPS System
- Welding

Maximum Ratings:

Characteristics	Symbol	Condition	Max.		Units
Peak Repetitive Reverse Voltage	V _{RRM}	-	35	401CNQ035	
Working Peak Reverse Voltage	V_{RWM}		40	401CNQ040	V
DC Blocking Voltage	V _R		45	401CNQ045	
Average Rectified Forward Current	le	50% duty cycle @T _C =1116°C,	200(Per Leg)		Α
	I _{F(AV)}	rectangular wave form	400(Per Device)		
Peak One Cycle Non-Repetitive	I _{FSM}	8.3 ms, half Sine pulse	4140		Α
Surge Current (Per Leg)	IFSIVI	c.o me, nan eme palee		1110	, ,
Non-Repetitive Avalanche	Eas	T _J =25℃,I _{AS} =40A,L=0.34mH 270		mJ	
Energy(Peg Leg)	LAG	19 20 0,143 10,1,2 0.0 11111		270	1110
Repetitive Avalanche Current		Current decaying linearly to zero			
(Peg Leg)	I _{AR}	in 1 µsec Frequency limited by		40	Α
		T _J max. V _A =1.5×V _R typical			

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com sales@ smc-diodes.com •









Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop(Per Leg)*	V _{F1}	@ 200A, Pulse, T _J = 25 °C @ 400A, Pulse, T _J = 25 °C	0.56 0.67	0.67 0.78	V
	V _{F2}	@ 200A, Pulse, T _J = 125 °C @ 400A, Pulse, T _J = 125 °C	0.50 0.60	0.56 0.68	V
Reverse Current(Per Leg)*	I _{R1}	$@V_R = \text{rated } V_{R_s} T_J = 25 ^{\circ}\text{C}$	0.2	20	mA
	I _{R2}	$@V_R = \text{rated } V_{R,} T_J = 125 ^{\circ}\text{C}$	100	180	mA
Junction Capacitance(Per leg)	Ст	$@V_R = 5V, T_C = 25 °C$ $f_{SIG} = 1MHz$	8600	10300	pF
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

^{*} Pulse width < 300 µs, duty cycle < 2%

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specific	Units	
Junction Temperature	TJ	-	-55 to +175		°C
Storage Temperature	T _{stg}	-	-55 to +175		°C
Typical Thermal Resistance Junction to Case(Per leg)	$R_{ heta JC}$	DC operation	0.20		°C/W
Typical Thermal Resistance Junction to Case(Per package)	$R_{ heta JC}$	DC operation	0.10		°C/W
Typical Thermal Resistance, case to Heat Sink	$R_{ heta cs}$	Mounting surface, smooth and greased	0.10		°C/W
Mounting Torque	T _M	-	Mounting Torque	24(min) 35(max)	- Kg-cm
			Terminal Torque	35(min) 46(max)	
Approximate Weight	wt	-	79 9		
Case Style	PRM4 Non-Isolated				





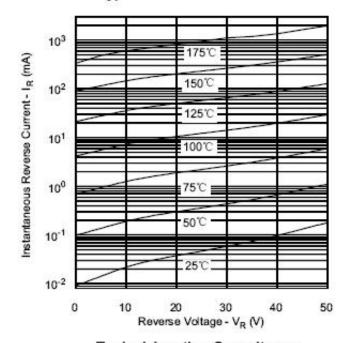


Ratings and Characteristics Curves

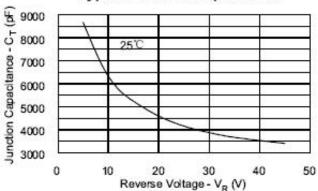
Typical Forward Characteristics

175°C Instantaneous Forward Current - 1_F (A) 10^{2} 125°C 25°C 0.2 0.7 0.8 0.3 0.4 0.5 0.6 Forward Voltage Drop - V_F (V)

Typical Reverse Characteristics



Typical Junction Capacitance



[•] China - Germany - Korea - Singapore - United States •

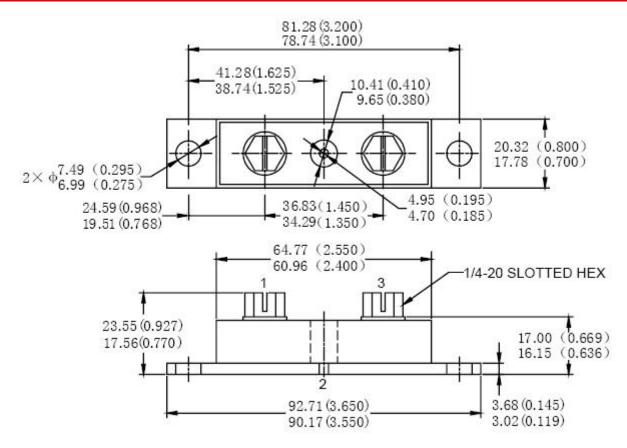




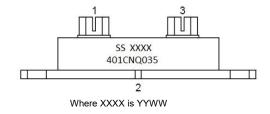




Mechanical Dimensions PRM4 Non-Isolated(Millimeters/Inches)



Marking Diagram



401CNQ035 = Part name SS = SS YY = Year WW = Week

Cautions: Molding resin Epoxy resin UL:94V-0

Ordering Information

Device	Package	Shipping
401CNQ SERIES	PRM4(Non- Isolated) (Pb-Free)	9 pcs/box

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

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